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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/696,198	10/28/2003	Chien-Ping Huang	60173(71987)	7288
21874 EDWARDS A1	7590 05/30/2007	OCE I I D	EXAM	INER
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BOSTON, MA 02205			ART UNIT	PAPER NUMBER
			2814	
			MAIL DATE	DELIVERY MODE
			05/30/2007	· PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)	
	10/696,198	HUANG, CHIEN-PING	
Office Action Summary	Examiner	Art Unit	
	Vikki H. Trinh	2814	
The MAILING DATE of this communication Period for Reply	appears on the cover sheet with th	e correspondence address	•
A SHORTENED STATUTORY PERIOD FOR RE THE MAILING DATE OF THIS COMMUNICATIO - Extensions of time may be available under the provisions of 37 CFF after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a - If NO period for reply is specified above, the maximum statutory per - Failure to reply within the set or extended period for reply will, by state of the second	N. R 1.136(a). In no event, however, may a reply be reply within the statutory minimum of thirty (30) riod will apply and will expire SIX (6) MONTHS fratute, cause the application to become ABANDO	e timely filed days will be considered timely. rom the mailing date of this communicat DNED (35 U.S.C. § 133).	tion.
Status			
1) Responsive to communication(s) filed on 2	7 February 2007		
	his action is non-final.		
3) Since this application is in condition for allo closed in accordance with the practice under	wance except for formal matters,		is
Disposition of Claims			
4) Claim(s) 1-8 is/are pending in the application 4a) Of the above claim(s) is/are without 5) Claim(s) is/are allowed. 6) Claim(s) 1-8 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and	drawn from consideration.		
Application Papers			
9) The specification is objected to by the Exam 10) The drawing(s) filed on is/are: a) a Applicant may not request that any objection to Replacement drawing sheet(s) including the cor	accepted or b) objected to by the drawing(s) be held in abeyance. □	See 37 CFR 1.85(a).	1(d)
11) The oath or declaration is objected to by the	· · · · · · · · · · · · · · · · · · ·	•	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for fore a) All b) Some * c) None of: 1. Certified copies of the priority docum 2. Certified copies of the priority docum 3. Copies of the certified copies of the papplication from the International Bur * See the attached detailed Office action for a	ents have been received. ents have been received in Applic priority documents have been rece reau (PCT Rule 17.2(a)).	eation Noeived in this National Stage	
Attachment(s)	not of the certified depice flot rece	1700	
Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948)	4) Interview Summ Paper No(s)/Mai		
Notice of Draftsperson's Patent Drawing Review (P10-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB. Paper No(s)/Mail Date		al Patent Application (PTO-152)	

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DETAILED ACTION

Claims Status

1. Claims 1-8 are pending in this present application.

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. The factual inquiries set forth in *Graham* v. *John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:
 - 1. Determining the scope and contents of the prior art.
 - 2. Ascertaining the differences between the prior art and the claims at issue.
 - 3. Resolving the level of ordinary skill in the pertinent art.
 - 4. Considering objective evidence present in the application indicating obviousness or nonobviousness.
- 4. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

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5. Claims 1-4, 6-8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ku (US 2004/0099945)

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Ku discloses a multi-chip package device with a heat sink 50 (fig. 4), comprising a chip carrier 10 (fig. 4); at least one first chip 30 (fig. 4) or 31 (fig. 4) mounted on and electrically connected to a surface of the chip carrier 10; at least one semiconductor package 20 (fig. 4) mounted on and electrically connected to the surface of the chip carrier 10 (fig. 1); wherein the package appears to be "slightly" thicker than the first chip (note that the examiner broadly interprets the term "slightly" since it does not denote a definite dimension) and the heat sink 50 (fig. 4) mounted via an adhesion layer (page 4, [0061], lines 3-5) on a surface of the first chip 30, 31 (fig. 4) and a surface of the semiconductor package 20 (fig. 4) that are opposite to surfaces of the first chip 30, 31 (fig. 4) and the semiconductor package 20 mounted on the chip carrier 10 (fig. 4). The at least one hollow part 504 (fig. 4) extending through the heat sink 50 is formed at an area of the heat sink free of contact with the first chip and the semiconductor package to release thermal stresses from the heat sink through the at least one hollow part that remains hollow. However, Ku does not explicitly teach that a portion of the heat sink attached to the first chip is made of thicker than another portion of the heat sink mounted on the package. Nevertheless, it would have been obvious to one of ordinary skills in the art at the time the invention was made to modify the invention of Ku with the portion of the heat sink attached to the first chip is made thicker than another portion of the heat sink mounted on the package, since it is a prima facie obvious to an artisan for optimization and experimentation to set a different thickness dimensions for the heat sink because applicants have not yet established any criticality or unexpected results for the different dimensions.

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Note that the specification contains no disclosure of either the critical nature of the claimed dimensions of any unexpected results arising therefrom. Where patentability is aid to be based upon particular chosen dimensions or upon another variable recited in a claim, the applicant must show that the chosen dimensions are critical. (In re Woodruff, 919 F.2d 1575, 1578 (Fed. Cir. 1990).)

As to claim 2, Ku teaches that the semiconductor package 20 (fig. 4) is a flip-chip ball grid array package (specification, page 1, [0004]).

As to claim 3, Ku teaches that the first chip 30 or 31 (fig. 4) is capable of being a graphic chip.

As to claim 4, Ku teaches that the first chip 30 or 31 (fig. 4) is capable of being a graphic processing unit.

As to claim 6, Ku teaches that the first chip 30 or 31 (fig. 4) is mounted at the center of the chip carrier 10 (fig. 4), and the semiconductor package 10 is mounted at a position on the chip carrier 10 corresponding to a corner of the heat sink 50.

As to claim 7, Ku teaches that at least one pair of the semiconductor packages 20 (fig.4) are mounted on the chip carrier 10 (fig. 4), and the hollow part 504 (fig. 4) of the heat sink 50 (fig. 4) is located between the semiconductor packages.

As to claim 8, at least one symmetrical pair (fig. 4) of the hollow parts 504 (fig. 4) are formed through the heat sink 24(fig.4).

6. Claim 5 is rejected under 35 U.S.C. 103(a) as being unpatentable over Ku in view of Behlen et al. (hereinafter Behlen) (5,598,033).

Ku discloses the invention substantially as claimed. However, Ku and Behlen do not explicitly teach that the semiconductor package is a Random Access Memory (RAM) unit.

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Behlen discloses an analogous BGA package 300 (fig. 3) having a carrier 338, solder bumps 314 (fig. 3), and chip 310 (fig. 3), wherein the package is a volatile RAM (col. 1, line 13).

Therefore, it would have been obvious to one of ordinary skills in the art at the time the invention was made to modify the invention of Ku with a RAM, as taught by Behlen, as merely a matter of selecting a type of device for packaging.

Response to Arguments

7. Applicant's arguments filed 02/27/2007 have been fully considered but they are moot in view of the new rejection.

Conclusion

8. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

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- 9. Any inquiry concerning this communication or earlier communications from the Examiner should be directed to Vikki Trinh whose telephone number is (571) 272-1719. The Examiner can normally be reached from Monday-Friday, 9:00 AM 5:30 PM Eastern Time. If attempts to reach the examiner by telephone are unsuccessful, the Examiner's supervisor, Mr. Wael Fahmy, can be reached at (571) 272-1705. The office fax number is 703-872-9306.
- 10. Any request for information regarding to the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Also, status information for published applications may be obtained from either Private PAIR or Public Pair. In addition, status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. If you have questions pertaining to the Private PAIR system, please contact the Electronic Business Center (EBC) at 866-217-9197 (toll free).
- Lastly, paper copies of cited U.S. patents and U.S. patent application publications will cease to be mailed to applicants with Office actions as of June 2004. Paper copies of foreign patents and non-patent literature will continue to be included with office actions. These cited U.S. patents and patent application publications are available for download via the Office's PAIR. As an alternate source, all U.S. patents and patent application publications are available on the USPTO web site (www.uspto.gov), from the Office of Public Records and from commercial sources. Applicants are referred to the Electronic Business Center (EBC) at http://www.uspto.gov/ebc/index.html or 1-866-217-9197 for information on this policy. Requests

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to restart a period for response due to a missing U.S. patent or patent application publications will not be granted.

Vikki Trinh, Patent Examiner AU 2814

> HOWARD WEISS PRIMARY EXAMINER